



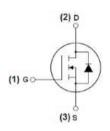
MJ N-Channel Enhancement Mode Power MOSFET

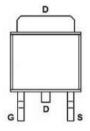
Description

The MJ6050KA uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- ightharpoonup V_{DS} =60V,I_D =50A R_{DS(ON)} <20m Ω @ V_{GS}=10V
- ◆ High density cell design for ultra low Rdson
- ◆ Fully characterized avalanche voltage and current
- ◆ Good stability and uniformity with high E_{AS}
- ◆ Excellent package for good heat dissipation
- ◆ Special process technology for high ESD capability



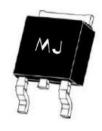


Application

◆ Power switching application

Uninterruptible power supply

Hard switched and high frequency circuits



Schematic diagram

Marking and pin assignment

TO-252-2L top view

100% UIS TESTED! 100% ΔVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJ6050KA	MJ6050KA	TO-252-2L	=	<u> </u>	-

Absolute Maximum Ratings (Tc =25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	60	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	lo	50	А
Drain Current-Continuous(Tc =100°C)	I _{D(100} ℃)	35.4	А
Pulsed Drain Current	Ірм	200	А
Maximum Power Dissipation	PD	85	W
Derating factor		0.57	W/°C
Single pulse avalanche energy (Note 5)	Eas	300	mJ
Operating Junction and Storage Temperature Range	TJ,TsTG	-55 To 175	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	Rejc	1.8	°C/W
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Electrical Characteristics (Tc =25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V I _D =250µA	60	-	-	V
Zero Gate Voltage Drain Current	loss	V _{DS} =60V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	lgss	V _{DS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	VGS(th)	V _{DS} =V _{GS} ,I _D =250µA	1.4	1.9	2.5	V
Drain-Source On-State Resistance	Rds(on)	V _{GS} =10V, I _D =20A	-	14	20	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =20A	18	-	-	S
Dynamic Characteristics (Note 4)	1		1			
Input Capacitance	Clss		_	2050	-	PF
Output Capacitance	Coss	V _{DS} =30V,V _{GS} =0V F=1.0MHz	-	158	-	PF
Reverse Transfer Capacitance	Crss		-	120	-	PF
Switching Characteristics (Note 4)	'					
Turn-on Delay Time	t _{d(on)}		_	7.4	-	nS
Turn-on Rise Time	tr		-	5.1	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{DD} =30V, R _L =6.7 Ω V _{GS} =10V,R _G =3 Ω	-	28.2	_	nS
Turn-Off Fall Time	tf	-	-	5.5	-	nS
Total Gate Charge	Qg		-	50	-	nC
Gate-Source Charge	Qgs	V _{DS} =30V,I _D =20A V _{GS} =10V	-	6	-	nC
Gate-Drain Charge	Qgd	-	-	15	-	nC
Drain-Source Diode Characteristics						<u> </u>
Diode Forward Voltage (Note 3)	VsD	V _{GS} =0V,I _S =20A	_	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	50	А
Reverse Recovery Time	trr	TJ=25°C, IF=20A	_	28	-	nS
Reverse Recovery Charge	Qrr	di/dt=100A/µs (Note 3)	_	40	-	nC
Forward Turn-On Time	ton	Intrinsic turn-on time is n	ealiaible(+	rn-on is d	ominated h	V S+ L

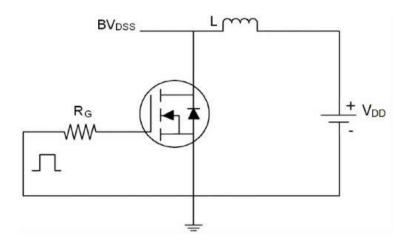
Notes:

- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, t ≤ 10 sec.
- ③ Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4 Guaranteed by design, not subject to production

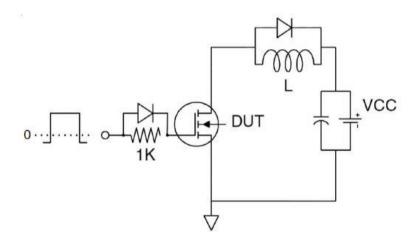




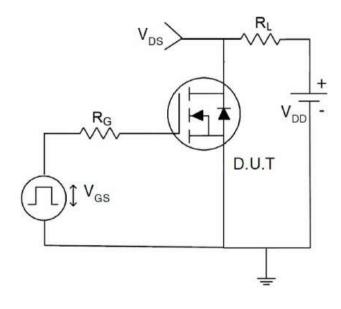
Test circuit



Eas test Circuit



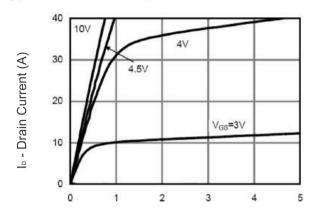
Gate charge test Circuit

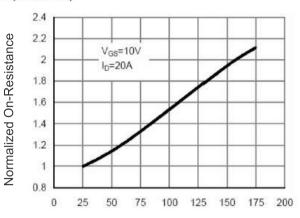


Switch Time Test Circuit



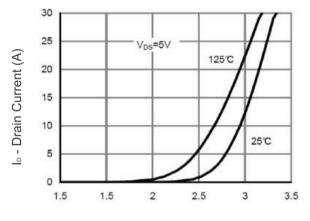
Typical Electrical and Thermal Characteristics (Curves)

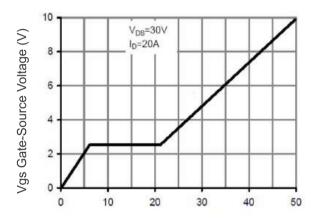




Vds Drain-Source Voltage (V) Figure 1 Output Characteristics

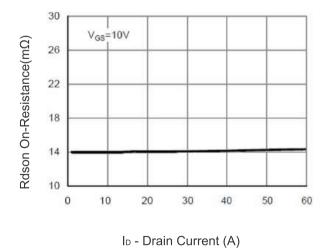
T_J -Junction Temperature(°C) Figure 4 Rdson-Junction Temperature





Vgs Gate-Source Voltage (V) Figure 2 Transfer Characteristics

Qg Gate Charge (nC) Figure 5 Gate Charge



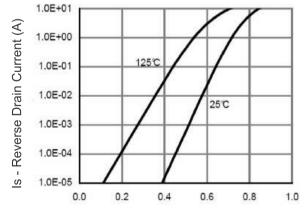
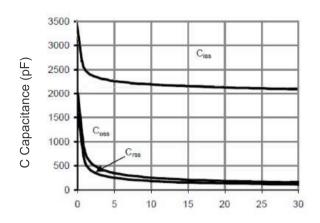


Figure 3 Rdson- Drain Current

Vsd Source-Drain Voltage (V) Figure 6 Source- Drain Diode Forward



Ib - Drain Current (A)

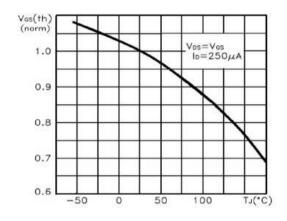


BVpss V_{GS}=0 (norm) lo=250μA 1.2 1.1 1.0 0.9

Vds Drain-Source Voltage (V) Figure 7 Capacitance vs Vds

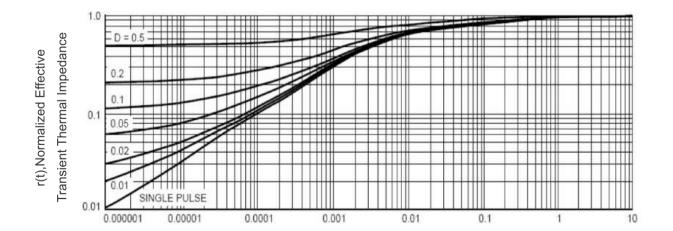
1000.0 100.0 limited 10.0 1.0 T_{J(M3X)}=175°C T_C=25°C 0.1 0.0 0.01 100 0.1 10 1000

T_J-Junction Temperature (°C) Figure 9 BVpss vs Junction Temperature



Vds Drain-Source Voltage (V) Figure 8 Safe Operation Area

T_J-Junction Temperature (°C) Figure 10 V_{GS(th)} vs Junction Temperature



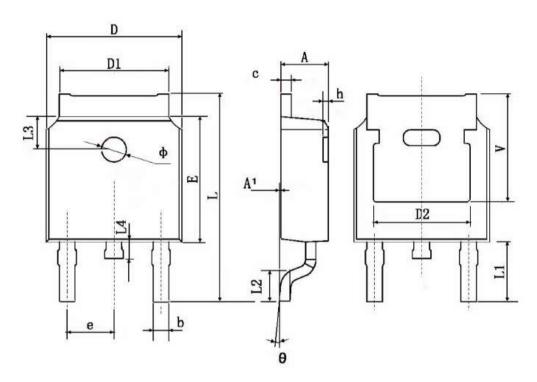
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance





TO-252 Package Information



Symbol	Dimensions	In Millimeters	Dimension	s In Inches
	Min.	Max.	Min.	Max.
Α	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
С	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.8	30 TYP.	0.190	TYP.
E	6.000	6.200	0.236	0.244
е	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900	TYP.	0.114 TYP.	
L2	1.400	1.700	0.055	0.067
L3	1.600	TYP.	0.063	TYP.
L4	0.600	1.000	0.024	0.039
Φ	1.100	1.300	0.043	0.051
θ	0°	8°	0 °	8°
h	0.000	0.300	0.000	0.012
V	5.350	5.350 TYP.		TYP.





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